

STX724

NPN MEDIUM POWER TRANSISTORS

Features

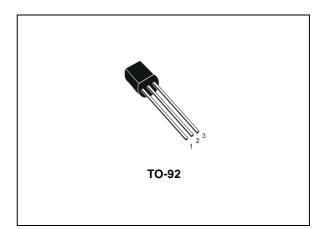
- TO-92 PACKAGE SUITABLE FOR THROUGH-HOLE PCB ASSEMBLY
- IN COMPLIANCE WITH THE 2002/93/EC EUROPEAN DIRECTIVE

Applications

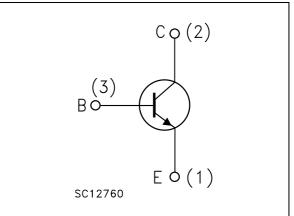
- VOLTAGE REGULATION
- RELAY DRIVER
- GENERIC SWITCH

Description

The STX724 is a NPN transistor manufactured using planar Technology resulting in rugged high performance devices.



Internal Schematic Diagram



Order codes

Part Number	Marking	Package	Packing
STX724	X724	TO-92	BULK

1

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Symbol	Parameter	Value	Unit V	
V _{CBO}	Collector-Base Voltage (I _E = 0)	60		
V _{CEO}	Collector-Emitter Voltage ($I_B = 0$)	30	V	
V_{EBO}	Collector-Base Voltage (I _C = 0)	5	V	
Ι _C	Collector Current	3	А	
I _{CM}	Collector Peak Current (t _P < 5ms)	6	А	
Ι _Β	Base Current	1	А	
I _{BM}	Base Peak Current (t _P < 5ms)	2	А	
P _{TOT}	Total dissipation at $T_c = 25^{\circ}C$	0.9	W	
T _{STG}	Storage Temperature -65 to 150		°C	
Τ _J	Max. Operating Junction Temperature	150		

Table 1. Absolute Maximum Rating

Table 2. Thermal Data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal Resistance Junction-Case Max	44.6	°C/W
R _{thj-amb}	Thermal Resistance Junction-Amb Max	139	°C/W



2 Electrical Characteristics

Symbol	Parameter Test Conditions		Min.	Тур.	Max.	Unit	
I _{CES}	Collector Cut-off Current $(V_{BE} = 0)$	$V_{CE} = 60V$.,,,,,	10	μΑ
I _{CEO}	Collector Cut-off Current $(I_B = 0)$	V _{CE} = 30V				100	μΑ
I _{EBO}	Emitter Cut-off Current $(I_{C} = 0)$	V _{EB} = 5V				10	μΑ
V _{(BR)CBO}	Collector-Base Breakdown Voltage (I _E = 0)	I _C = 100μA		60			V
V _{(BR)CEO} Note 1	Collector-Emitter Breakdown Voltage (I _B = 0)	I _C = 10 mA		30			V
V _{(BR)EBO}	Collector-Emitter Breakdown Voltage (I _C = 0)	I _E = 100 μA		5			V
V _{CE(sat)} Note 1	Collector-Emitter Saturation Voltage	$I_{C} = 1 A$ $I_{C} = 2 A$ $I_{C} = 3 A$	l _B = 50 mA I _B = 100 mA I _B = 150 mA			0.4 0.7 1.1	< < <
V _{BE(sat)} Note 1	Base-Emitter Saturation Voltage	I _C = 2 A	l _B = 100 mA			1.2	V
h _{FE}	DC Current Gain	$I_{C} = 100 \text{ mA}$ $I_{C} = 1 \text{ A}$ $I_{C} = 3 \text{ A}$	V _{CE} = 2 V V _{CE} = 2 V V _{CE} = 2 V	100 80 30		300	
f _T	Transistor Frequency	V _{CE} = 10 V	I _c = 0.1 A		100		MHz

Table 3.Electrical Characteristics ($T_{CASE} = 25^{\circ}C$; unless otherwise specified)

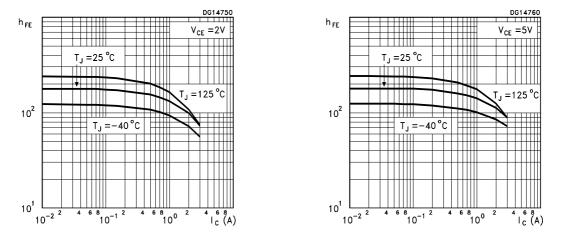
1 Pulsed duration = 300 μ s, duty cycle \leq 1.5%.

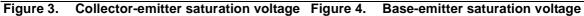


2.1 Electrical characteristics (curve)

Figure 1. DC Current Gain

Figure 2. DC Current Gain





V_{BE(sat)} (V)

1.0

0.9

0.8

0.7

0.6

0.5

0.4

10⁻²

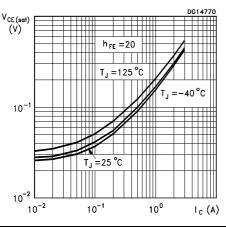
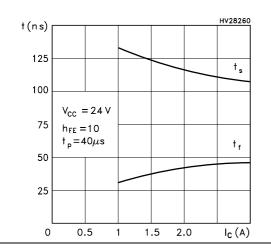
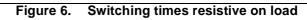


Figure 5. Switching times on resistive load





⁸10⁻¹

h _{FE} =20

T_ = 25 °C

Γ_{.1} =−40

T_J =125 °C

8 10⁰ ้ I _c (A)

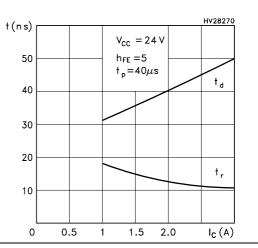
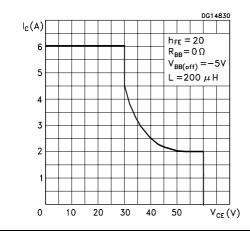


Figure 7. Reverse biased area





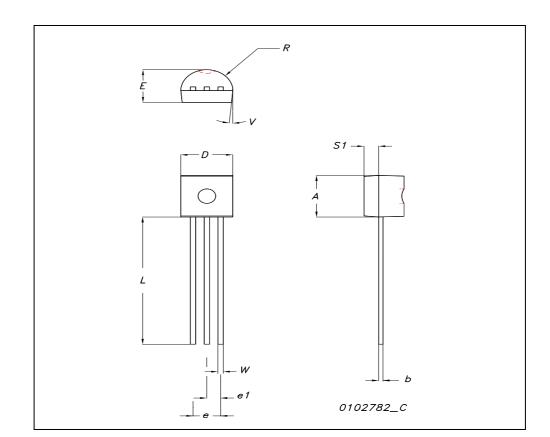
3 Package Mechanical Data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com



DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
А	4.32		4.95	0.170		0.194
b	0.36		0.51	0.014		0.020
D	4.45		4.95	0.175		0.194
Е	3.30		3.94	0.130		0.155
е	2.41		2.67	0.094		0.105
e1	1.14		1.40	0.044		0.055
L	12.70		15.49	0.50		0.610
R	2.16		2.41	0.085		0.094
S1	0.92		1.52	0.036		0.060
W	0.41		0.56	0.016		0.022
V		5°			5°	

TO-92 MECHANICAL DATA





4 Revision History

Date	Revision	Changes
17-Oct-2005	1	First release



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